SILICON POWER TRANSISTOR 2SA1010

PNP SILICON EPITAXIAL TRANSISTOR FOR HIGH-VOLTAGE HIGH-SPEED SWITCHING

The 2SA1010 is a mold power transistor developed for highvoltage high-speed switching, and is ideal for use as a driver in devices such as switching regulators, DC/DC converters, and highfrequency power amplifiers.

FEATURES

- Low collector saturation voltage
- · Fast switching speed

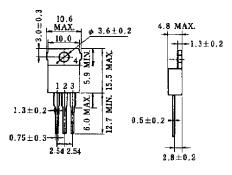
NEC

Complementary transistor: 2SC2334

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	-100	V
Collector to emitter voltage	VCEO	-100	V
Emitter to base voltage	Vebo	-7.0	V
Collector current (DC)	IC(DC)	-7.0	А
Collector current (pulse)	C(pulse)*	-15	А
Base current (DC)	B(DC)	-3.5	А
Total power dissipation	P⊤ (Tc = 25 °C)	40	W
Total power dissipation	P⊤ (Ta = 25 °C)	1.5	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

* PW \leq 300 μ s, duty cycle \leq 10%



PACKAGE DRAWING (UNIT: mm)

Pin Connection

3. Emitter

4. Fin (Collector)

EIAJ : SC-46 JEDEC : TO-220AB IEC : --

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

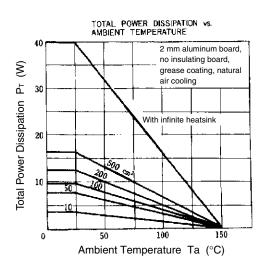
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector to emitter voltage	VCEO(SUS)	$I_{C} = -5.0 \text{ A}, I_{B1} = -0.5 \text{ A}, L = 1 \text{ mH}$	-100			V
Collector to emitter voltage	VCEX(SUS)1	$\label{eq:lc} \begin{array}{l} I_{C} = -5.0 \mbox{ A}, I_{B1} = -I_{B2} = -0.5 \mbox{ A}, \\ V_{BE(OFF)} = 5.0 \mbox{ V}, L = 180 \mu \mbox{ H}, \mbox{ clamped} \end{array}$	-100			V
Collector to emitter voltage	VCEX(SUS)2	$\label{eq:lc} \begin{split} I_{C} &= -10 \text{ A}, \ I_{B1} = -1.0 \text{ A}, \ I_{B2} = -0.5 \text{ A}, \\ V_{BE(OFF)} &= 5.0 \text{ V}, \ L = 180 \ \mu\text{H}, \ clamped \end{split}$	-100			V
Collector cutoff current	Ісво	$V_{CB} = -100 \text{ V}, \text{ I}_{E} = 0$			-10	μA
Collector cutoff current	ICER	$V_{CE} = -100 \text{ V}, \text{ R}_{BE} = 51 \Omega, \text{ Ta} = 125 ^{\circ}\text{C}$			-1.0	mA
Collector cutoff current	ICEX1	$V_{\text{CE}} = -100 \text{ V}, \text{ V}_{\text{BE(OFF)}} = 1.5 \text{ V}$			-10	μA
Collector cutoff current	ICEX2	$V_{CE} = -100 \text{ V}, \text{ V}_{BE(OFF)} = 1.5 \text{ V},$ Ta = 125 °C			-1.0	mA
Emitter cutoff current	Іево	V _{EB} = -5.0 V, Ic = 0			-10	μA
DC current gain	hfe1	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}^*$	40		200	
DC current gain	hfe2	Vce = -5.0 V, Ic = -3.0 A*	40		200	
DC current gain	hfeз	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -5.0 \text{ A}^*$	20			
Collector saturation voltage	VCE(sat)	$I_{C} = -5.0 \text{ A}, I_{B} = -0.5 \text{ A}^{*}$			-0.6	V
Base saturation voltage	V _{BE(sat)}	Ic = -5.0 A, I _B = -0.5 A*			-1.5	V
Turn-on time	ton	Ic = -5.0 A, R _L = 10 Ω,			0.5	μs
Storage time	tstg	$I_{B1} = -I_{B2} = -0.5 \text{ A}, \text{ Vcc} \cong -50 \text{ V}$ Refer to the test circuit.			1.5	μs
Fall time	tr				0.5	μs

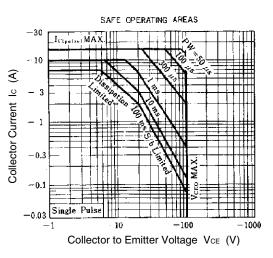
* Pulse test PW \leq 350 μ s, duty cycle \leq 2%

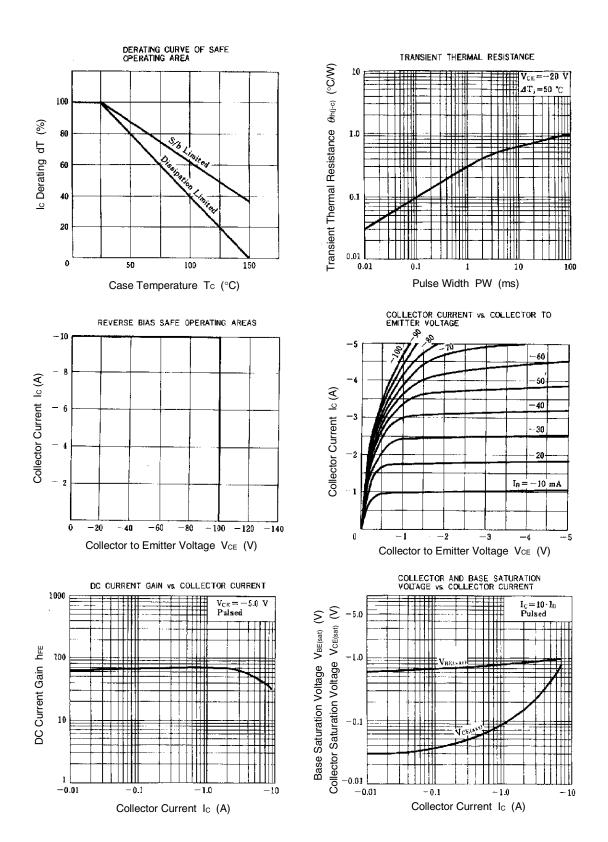
hfe CLASSIFICATION

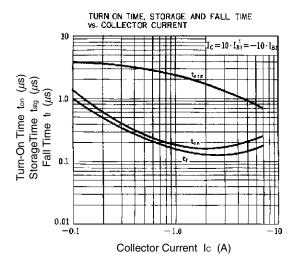
Marking	М	L	к
hfe2	40 to 80	60 to 120	100 to 200

TYPICAL CHARACTERISTICS (Ta = 25°C)

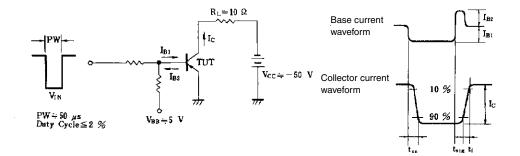








SWITCHING TIME (t_{on}, t_{stg}, t_{f}) TEST CIRCUIT



[MEMO]

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